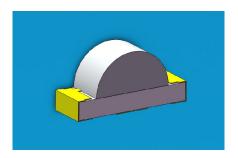


DATASHEET

SMD • B 12-21C/GHC-HS2U1G/2C



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free (Br < 900ppm , Cl < 900ppm , Br+Cl < 1500ppm)

Description

- The 12-21C SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Chip Materials	Emitted Color	Resin Color	
InGaN	Brilliant Green	Water Clear	

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I _F	25	mA
eak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA
Power Dissipation	Pd	95	mW
Electrostatic Discharge	ESD _{HBM}	150	V
Operating Temperature	T_{opr}	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +90	
Soldering Temperature	Tsol	· ·	or 10 sec. 3 sec.



Electro-Optical Characteristics (Ta=25

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	225		565	mcd	_
Viewing Angle	2θ _{1/2}		100		deg	_
Peak Wavelength	λр		518		nm	- L 20 A
Dominant Wavelength	λd	525		535	nm	¯ I _F =20mA _
Spectrum Radiation Bandwidth	λ		35		nm	_
Forward Voltage	V _F	2.70		3.70	V	
Reverse Current	I _R			50	μΑ	V _R =5V
Note: 1.Tolerance of Luminous Intensity: ±11% 2.Tolerance of Dominant Wavelength ±1nm 3. Tolerance of Forward Voltage: ±0.05V						

Note:

- 1. Tolerance of Luminous Intensity: ±11%
- 2. Tolerance of Dominant Wavelength ±1nm
- 3. Tolerance of Forward Voltage: ±0.05V



Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
S2	225	285		
T1	285	360		I -00m A
T2	360	450	mcd	I _F =20mA
U1	450	565		

Bin Range Of Dom. Wavelength

Bin Code	Min.	Max.	Unit	Condition
Υ	525	530		L -00m A
Z	530	535	mm nm	I _F =20mA

Bin Range Of Forward Voltage

Bin Code	Min.	Max.	Unit	Condition
34	2.70	2.80		
35	2.80	2.90		
36	2.90	3.00		
37	3.00	3.10		
38	3.10	3.20	V	I _F =20mA
39	3.20	3.30		1 _F -2011A
40	3.30	3.40		
41	3.40	3.50		
42	3.50	3.60		
43	3.60	3.70		

Note:

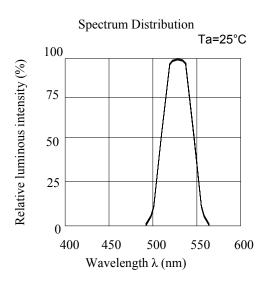
1. Tolerance of Luminous Intensity: ±11%

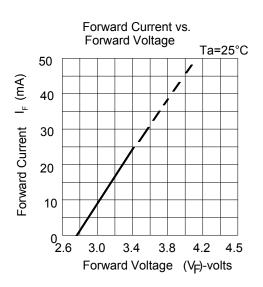
2. Tolerance of Dominant Wavelength ±1nm

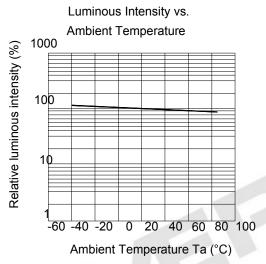
3. Tolerance of Forward Voltage: ±0.05V

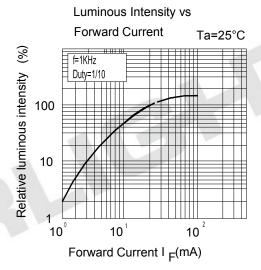


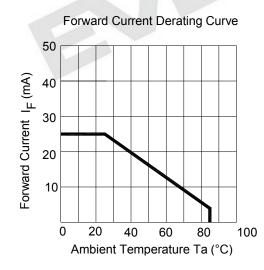
Typical Electro-Optical Characteristics Curves

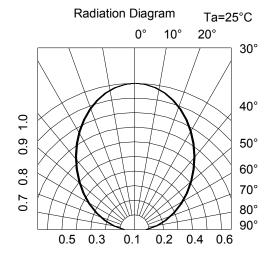








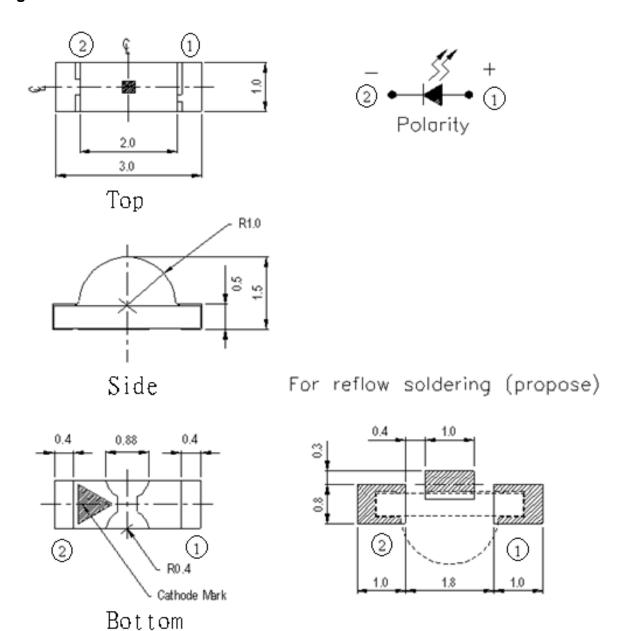




LifecyclePhase:

nired Period: Forever

Package Dimension

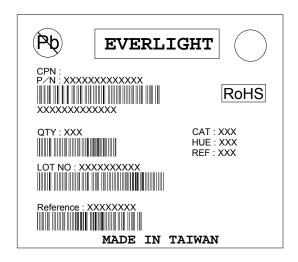


Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

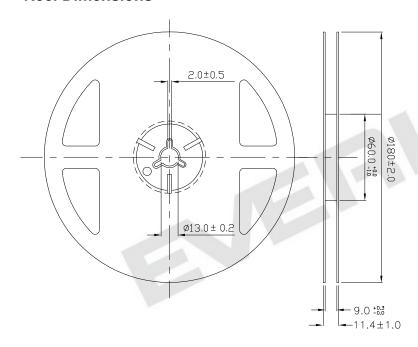


Moisture Resistant Packing Materials Label Explanation



- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- · REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions

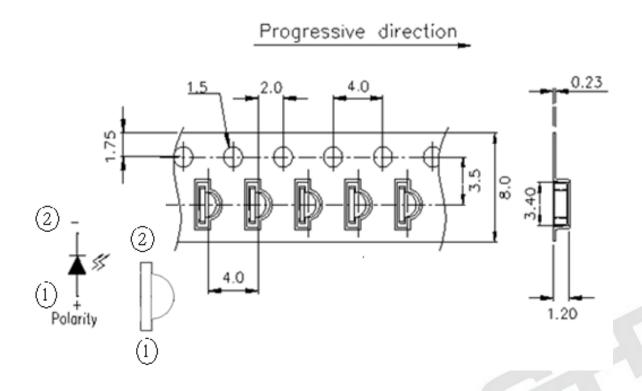


Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

LifecyclePhase:

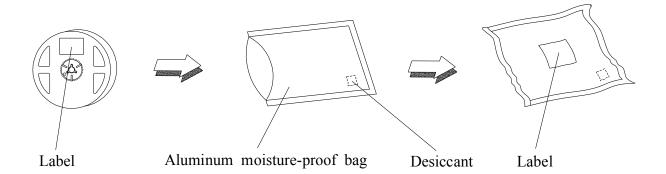


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Moisture Resistant Packaging



LifecyclePhase:

Approved



Precautions For Use

1. Over-current-proof

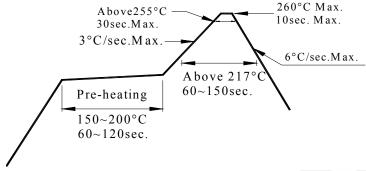
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 After opening the package: The LEDs should be kept at 30 or less and 60%RH or less.
- 2.3 The LEDs should be used within 168 hours (7days) after opening the package.

If unused LEDs remain, it should be stored in moisture proof packages.

- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5 for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



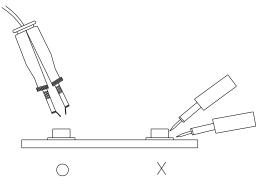
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



LifecyclePhase:

mired Period: Forever



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.



单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)